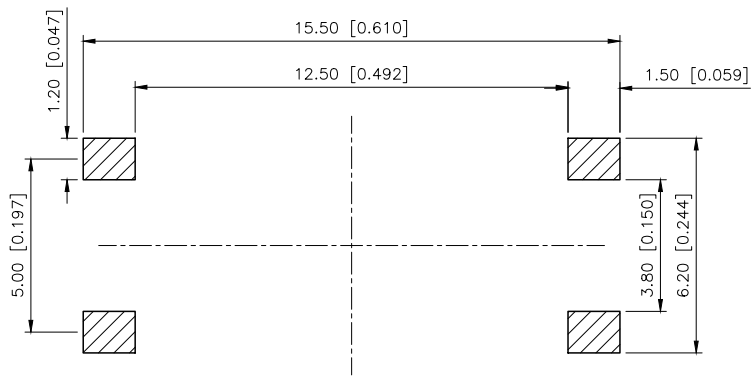
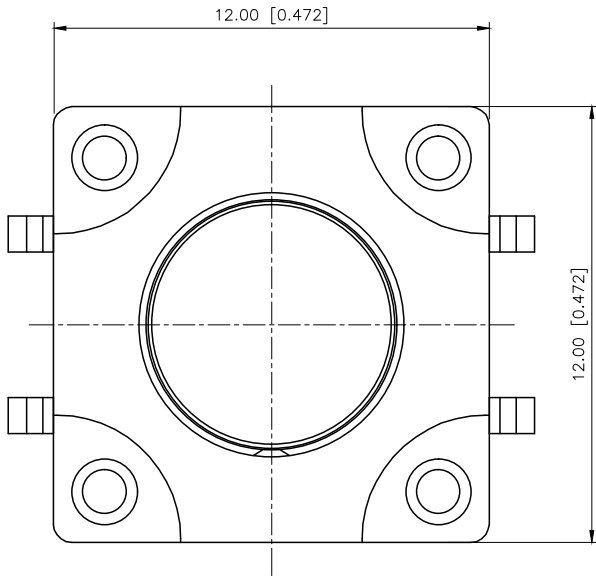
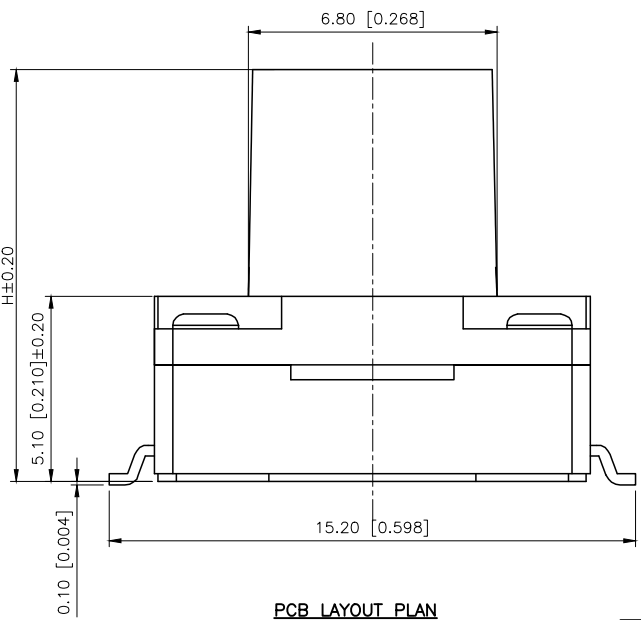


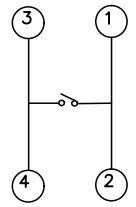
REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.06.07	阿树



Code-x	H	Code-x	H
E	6.00	Q	12.00
F	6.50	R	12.50
G	7.00	S	13.00
H	7.50	T	13.50
I	8.00	U	14.00
J	8.50	V	15.00
K	9.00	W	15.50
L	9.50	X	16.00
M	10.00	Y	16.50
N	10.50	Z	17.00
O	11.00	18	18.00
P	11.50	19	19.00



PCB LAYOUT PLAN



CIRCUIT DIAGRAM

SPECIFICATION
Contact Rating: 50mA,12V DC
Contact Resistance: 100mΩ max
Insulation Resistance: 100MΩ min.500V DC
Dielectric Strength: 250V AC/1minute
Travel: 0.25mm
Operating Temp: -30℃~+85℃
Storage Temp: -30℃~+80℃

PAPT NO	TS-FS1212T-X-X
Operating Force	A:100gf B:160gf C:260gf
Height	Code-x

⑤	Terminal	4	Brass (0.30t)	Plating silvering
④	Contact	1	F.ag/SUS	Natural
③	Base	1	PA46	
②	Cover	1	PA46	
①	Keystake	1	PA46	

ITEM	PAPT	NAMF	QTY	MATERIAL	FINISHING
DESIGN	阿树	VIEW:		MODEL TYPE: TACT SWITCH	
CHECKED		UNIT:	mm/in	PART NO.: TS-FS1212T-X-X	
APPROVED		SIZE:	A4	DWG NO.:	

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERAUCES	



A

B

C

D

A

B

C

D